JK-nSMD035-30 PPTC DEVICES

Part Number: Q/JKTD-30-035

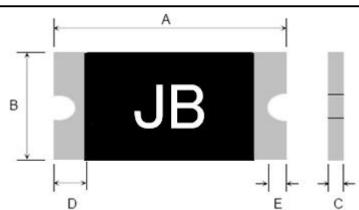
Edition: A0

Page No: 1 OF 3









Terminal pad materials: Tin-Plated Nickle-copper

Terminal pad solderability: Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.

Marking: JB=1206(035)

Table1 :DIMENTION(Unit : mm)

Model	Marking	A		В		С		D	Е
		Min.	Max.	Min.	Max.	Min.	Max	Min.	Min.
JK-nSMD035-30	JВ	3.00	3.50	1.50	1.80	0.50	1.2	0.15	0.10

Table2:PERFORMANCE RATINGS:

Model	V_{max}	I _{max}	I _{hold}	I _{trip}	Pd	Maxin	num	Resis	tance
			@25℃	@25°C	Тур	Time To	Trip		
						Current	Time	Ri _{min}	R1 _{max}
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)
JK-nSMD035-30	30	40	0.35	0.75	0.6	8.0	0.10	0.250	1.500

Table3:Test Conditons and Standards

Item	Test Conditon	Standard		
Initial Resistance	25℃	$0.2500{\sim}1.500\Omega$		
I_{H}	25℃, 0.35A, 30min	No Trip		
Ttrip	25℃, 8.0A	≤0.10s		
Trip endurance	30V, 40A, 1hr	No arcing or burning		

Operating Temperature: -40°C TO 85°C

Packaging: Bulk,5000pcs per bag

SHENZHEN JINRUI ELECTRONIC MATERIAL CO.,LTD

JK-nSMD035 PPTC DEVICES

Part Number: Q/JKTD-30-035

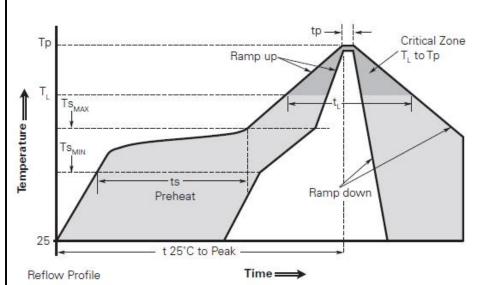


Edition: A0
Page No: 2 OF 3





Solder reflow conditions



Profile Feature	Pb-Free Assembly 3°C/second max.			
Average ramp up rate (Ts _{MAX} to Tp)				
Preheat				
 Temperature min. (Ts_{MIN}) 	150°C			
 Temperature max. (Ts_{MAX}) 	200°C			
 Time (ts_{MIN} to ts_{MAX}) 	60-120 seconds			
Time maintained above:				
• Temperature (T _L)	217°C			
• Time (t _L)	60-150 seconds			
Peak/Classification temperature (Tp)	260°C			
Time within 5°C of actual peak temperat	ure			
Time (tp)	30 seconds max.			
Ramp down rate	3°C/second max.			
Time 25°C to peak temperature	8 minutes max.			

Note: All temperatures refer to topside of the package, measured on the package body surface.

- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.
- Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25mm (0.010inch).
- Devices can be cleaned using standard industry methods and solvents.
- Soldering temprature profile meets RoHs leadfree process.

Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements

SHENZHEN JINRUI ELECTRONIC MATERIAL CO.,LTD

JK-nSMD035 PPTC DEVICES

Part Number: Q/JKTD-30-035



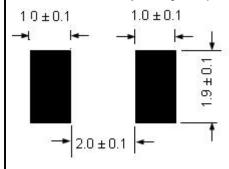
Edition: A0

Page No: 3 OF 3





Recommended pad layout (mm)



WARNING

- · Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- · PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- · Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- · Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- · Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- · Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices.PPTC SMD can be cleaned by standard methods.
- · Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profilecould negatively impact solderability performance of our devices.

SHENZHEN JINRUI ELECTRONIC MATERIAL CO.,LTD

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Resettable Fuses - PPTC category:

Click to view products by Jinrui Electronic Materials manufacturer:

Other Similar products are found below:

0001.1010.G D38999/20WG39JN F02B250V1-4AS 9728214S-2(621) RF0627-000 RF2534-000 ASMD185-2 EN2997S61212AN EN2997SE61203AN BK-ABC-V-5-R LR4-550RAF SMD125-2 F60C500V20AS RF0078-000 RF1548-000 RF1973-000 RF2171-000 RF2531-000 RF2533-000 RF2550-000 TR600-150Q-B-0.5-0.130 BK-AGX-20 5E4795/04-1502 EN2997S61212MN EN2997SE61203MN EN2997SE61212AN EN2997SE61212MN EN2997KE61212MN EN2997KE61212AN EN2997KE61212AN BK1/S505-1.25-R TR-3216FF20-R TRF250-080T-B-1.0-0.125 JT06RT1832BN014 S-3-2-10 SMD100-2 FRN-R-5-6-10 FRS-R-3-2-10 LP-CC-2-1-2 LPS-RK-3-2-10SP BK-AGC-1-8-R BK-AGC-2-10-R BK-AGC-7-1-2 BK-GDC-500MA BK-MDL-1-6-10-R BK-SFE-4 BK-ABC-1-R BK-C518-250-R BK-GDB-2A